

Product Disassembly Instructions

Product Category:

Panel PC

Product Marketing Name / Model:

PPC-3150SW

Purpose: The document provides the basic instructions for the disassembly of products to remove components and materials requiring selective treatment, as defined by EU directive 2002/96/EC and 2012/19/EU, Waste Electrical and Electronic Equipment (WEEE).

1.0 Items Requiring Selective Treatment

1.1 Items listed below are classified as requiring selective treatment.









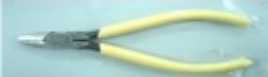



Item Description	Notes	Quantity of items included in product
Printed Circuit Boards (PCB) or Printed Circuit Assemblies (PCA)	With a surface greater than 10 sq. cm Mother board, Card Reader board, USB Daughter board, LID Daughter board	7
Batteries	All types including standard alkaline and lithium coin or button style batteries 6cell battery or 9 cell battery, and RTC battery	1
External electrical cables and Power cord		0
Liquid Crystal Displays (LCD) with a surface greater than 100 sq cm	Includes background illuminated displays with gas discharge lamps	1
Cathode Ray Tubes (CRT)		0
Gas Discharge Lamps		0
Electrolytic Capacitors / Condensers measuring greater than 2.5 cm in diameter or height		0

Item Description	Notes	Quantity of items included in product
Mercury-containing components	For example, mercury in lamps, display backlights, scanner lamps, switches, batteries	0
Capacitors / condensers (Containing PCB)		0

Plastics containing Brominated Flame Retardants weighing > 25 grams	(Not including PCBs or PCAs already listed as a separate item above)	0
Components and parts containing toner and ink, including liquids, semi-liquids (gel/paste) and toner	Include the cartridges, print heads, tubes, vent chambers, and service stations.	0
Asbestos waste and components which contain asbestos		0
Components containing refractory ceramic fibers		0
Chlorofluorocarbons (CFC), hydrochlorofluorocarbons (HCFC) or hydrofluorocarbons(HFC), hydrocarbons (HC)		0
Components, parts and materials containing radioactive substances		0

2.0 Disassembly Tool

List the tools that would typically be used to disassemble the product to a point where components and materials can be removed.

Disassembly Tool	Picture
Screwdriver	 
Lever	 
Star Screwdriver	 
Hexagon Driver	 
Slanted pliers	
Pliers	
Hammer	
Knife	

3.0 Product Disassembly Process

3.1 List the basic steps that should typically be followed to remove components and materials.

A. Disassembly Box module.

- A-1. Disassembly 9 pcs screw to remove the MB cover.
- A-2. Disassembly 2pcs antenna rubber cap from MB cover.
- A-3. Disassembly 4 pcs screw to separate the HDD/SSD and HDD/SSD bracket.
- A-4. Disassembly 4 pcs screw to remove the HDD/SSD tray from middle cover.
- A-5. Disassembly 2 pcs screw to remove the antenna bracket from middle cover.
- A-6. Disassembly DDR module from DDR socket.
- A-7. Disassembly mSATA card(2pcs screw) and Mini PCIe card(2pcs screw) from each socket.
- A-8. Remove RTC battery wire cable.
- A-9. Disassembly Hex 2pcs from COM port, screw 7pcs from mother board to separate the mother board and chassis.
- A-10. Disassembly 3pcs screw to remove IO Bracket.
- A-11. Disassembly 1 pcs screw to remove Line out Cable.
- A-12. Disassembly Hex 2 pcs screw to remove DB9 Cable.

B. Disassembly Panel module.

- B-1. Disassembly screw 10pcs to remove the middle cover.
- B-2. Disassembly screw 4pcs to remove the Speaker module.
- B-3. Disassembly screw 2pcs to remove the Touch control board.
- B-4. Disassembly Hex 2pcs to separate the Touch control board bracket.
- B-5. Disassembly screw 2pcs to remove Hole baffle plat.
- B-6. Disassembly screw 6pcs to remove the LED sub-assembly from Front Bezel.
- B-7. Disassembly screw 4pcs to separate the LCD bracket left and right with LCD module.
- B-8. Separate the LCD sponge from LCD opening bezel.
- B-9. Disassembly screw 1pcs to remove the LED indicator board.
- B-10. Remove the waterproof from front bezel.

3.2 Exploded view drawing.

